KEMET Part Number: C0603C332K3GECTU

(C0603C332K3GEC7867)



ESD SMD Comm C0G, Ceramic, Electro Static Discharge, 3300 pF, 10%, 25 VDC, C0G, SMD, MLCC, Temperature Stable, Electro Static Discharge, Class I, 0603



Dimensions		
L	1.6mm +/-0.15mm	
W	0.8mm +/-0.15mm	
Т	0.8mm +/-0.07mm	
S	0.7mm MIN	
В	0.35mm +/-0.15mm	

Packaging Specifications		
Packaging:	T&R, 180mm, Paper Tape	
Packaging Quantity:	4000	

General Information	
Supplier:	KEMET
Series:	ESD SMD Comm C0G
Style:	SMD Chip
Description:	SMD, MLCC, Temperature Stable, Electro Static Discharge, Class I
Features:	Temperature Stable, Low ESR, Class I
RoHS:	Yes
Termination:	Tin
Marking:	No
Chip Size:	0603

Specifications		
Capacitance:	3300 pF	
Capacitance Tolerance:	10%	
Voltage DC:	25 VDC	
ESD Level per AEC-Q200:	16,000 V ESD Level	
Dielectric Withstanding Voltage:	62.5 V	
Temperature Range:	-55/+125C	
Temperature Coefficient:	COG	
Dissipation Factor:	0.10% 1kHz 25C	
Aging Rate:	0% Loss/Decade Hour	
Insulation Resistance:	100 GOhms	

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